DECLARATION FOR PATENT APPLICATION

Docket Number (Optional) MR2685-145

As a below named inventor, I hereby d clare that:

My residenc, post office address and citiz inship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint Inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled BIODEGRADABLE AND BIOACTIVE GLASS-CERAMICS, AND METHOD which STARRIGATING THESS AND Following box is checked: , the specification of as United States Application Number or PCT International Application was filed on _____ (if applicable). Number ___ and was amended on _____ I her by state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56. I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed. Priority Not Claimed Prior Foreign Application(s) KR 2 September, 2002 2002-52566 (Day/Month/Year Filed) (Country) (Number) (Country) (Day/Month/Year Filed) (Number) I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below. (Filing Date) (Application Number) (Application Number) (Filing Date) I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112. I acknowledge the duty to disclose Information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application. (Filing Date) (Status-patented, pending, abandoned) (Application Number) (Filing Date) (Status-patented, pending, abandoned) (Application Number) I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: MORTON J. ROSENBERG, ESG., REG. # 26,049; DAVID R. WOOD, #53,868; DAVID I. KLEIN, ESQ., REG. # 33,253; JUN Y. LEE, ESQ., REG. # 40,262 HARRY L. SERNAKER, #50,595; MORTON J. ROSENBERG at telephone number 410-465-6678 Address all telephone calls to ROSENBERG, KLEIN & LEE Address all correspondence to 3458 FLLICOTT CENTER DRIVE-SUITE 101 ELLICOTT CITY, MD 21043 FAX #: 410-461-3067 E-MAIL ADDRESS: rkl@rklpatlaw.com I her by declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name) Hyun Seung YU (17 IS FAMILY NAME)

Hyun Seung YU (17 IS FAMILY NAME)

Hyun Seung YU (17 IS FAMILY NAME) Korea Citizenship Euncheon 2 danii Apt. 204-608, 1707-1 Bongcheon-dong, Kwanak-ku, Seoul, Korea Mailing Address ___ Full name of second joint inventor, if any (given name, family name) Kug Sun HONG (HONG IS FAMILY NAME)
Sec nd Inv ntor's signature

Lug Lug Lug Date 21 August 2003.

Citizenship Korea Korea Citizenship Mailing Address Sampoong Apt. 11-1502, Seocho 4-dong, Seocho-ku, Seoul, Korea

Additional Inventors are being named on separately numbered sheets attached hereto.

wentor's Signature	•	Date
	Jom Cin	A48 20 2003
itizenship		749 20 2003
	Korea	
iling Address		
	Ggumdongsan Apt. 1908-901, Sang-dong, Wonmi-ku, B	ucheon-si, Gyeonggi-do, Korea
		1
		Ę
		Ē
eurth Joint Invento		£
urth Joint Invento	or Dong Ho LEE (LEE IS FAMILY NAME)	- £
urth Joint Invento	Dong Ho LEE (LEE IS FAMILY NAME)	. Date
	Dong Ho LEE (LEE IS FAMILY NAME)	_
	Dong Ho LEE (LEE IS FAMILY NAME)	Date 21 August 20
entor's Signature	Dong Ho LEE (LEE IS FAMILY NAME) Nong Ho Lee	_
rentor's Signature	Dong Ho LEE (LEE IS FAMILY NAME)	_

Fifth Joint Inventor	Choon Ki LEE (LEE IS FAMILY NAME)	
Inventor's Signature	Choon Ki lee	24. Aug. 2053
Citizenship	Korea	
Mailing Address	Jinjoo Apt. 6-506, 20-4 Shincheon-dong, Songpa-ku, Seoul, Korea	

Sixth Joint Inventor	Bong Soon CHANG (CHANG IS FAMILY NAME)			
Inventor's Signature	Boy Soon Ches	Date 2/.	Aug.	2003.
Citizenship Mailing Address	Korez)			
	Samboo Apt. 101-302, 147 Haengdang-dong, Seongdong-ku, Seoul, Korea			

Third Joint triventor Deug Joong KIM (KIM IS FAMILY NAME)	
nventor's Signature LT Kim	Date 21. Aug, 2003
Cilizenship Korea	
Mailing Address Hanshin Apt. 216-901, Jamwon-dong, Seocho-ku, Seoul, Korea	

	Jun Hyuk SEO (SEO IS FAMILY NAME)	
nventor's Signature	(connlight	Date 2003. A. 2
Citizenship		
	Korea	
Mailing Address	202, 1020-1 Sadang 1-dong, Dongjak-ku, Seoul, Korea	

Fifth Joint Inventor	Jae Hyup LEE (LEE IS FAMILY NAME)	
Citizenship	Tax Typp few Korea	2003. P. 2/
Mailing Address	Kyungnam Apt. 1-308, 73 Ssangmoon-dong, Dobong-ku, Seoul, Korea	

Sixth Joint Invento	Ki Soo PARK (PARK IS FAMILY NAME)	
Inventor's Signatur	Parte term	Date
Citizenship	Korea	2003. 8.2/
Mailing Address	103-19, Sillim 2-dong, Kwanak-ku Seoul, Korea	